

Q3-Class HiperFET[™] Power MOSFET

IXFT18N100Q3 IXFH18N100Q3

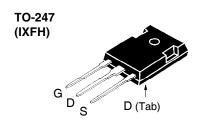
 $V_{DSS} = 1000V$ $I_{D25} = 18A$ $R_{DS(an)} \le 660 m\Omega$

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier



TO-268 (IXFT)	GS
	D (Tab)

Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	T _J = 25°C to 150°C	1000	V	
\mathbf{V}_{DGR}	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}, R_{gs} = 1\text{M}\Omega$	1000	V	
V _{GSS}	Continuous	± 30	V	
V _{GSM}	Transient	± 40	V	
I _{D25}	$T_{c} = 25^{\circ}C$	18	Α	
I _{DM}	$\rm T_{_{\rm C}}$ = 25°C, Pulse Width Limited by $\rm T_{_{\rm JM}}$	60	Α	
IA	T _C = 25°C	18	Α	
E _{as}	$T_{c} = 25^{\circ}C$	1.5	J	
dv/dt	$I_{_{S}} \le I_{_{DM}}, V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$	50	V/ns	
P _D	T _C = 25°C	830	W	
T _J		-55 +150	°C	
\mathbf{T}_{JM}		150	°C	
T _{stg}		-55 +150	°C	
T _L	Maximum Lead Temperature for Soldering	300	°C	
T _{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C	
M _d	Mounting Torque (TO-247)	1.13 / 10	Nm/lb.in.	
Weight	TO-268 TO-247	4.0 6.0	g g	
-	.02.		9 	



G = Gate	D	=	Drain
S = Source	Tab	=	Drain

Features

- Low Intrinsic Gate Resistance
- International Standard Packages
- Low Package Inductance
- Fast Intrinsic Rectifier
- Low R_{DS(on)} and Q_G

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- DC-DC Converters
- Battery Chargers
- Switch-Mode and Resonant-Mode Power Supplies
- DC Choppers
- Temperature and Lighting Controls

SymbolTest ConditionsCharacter $(T_J = 25^{\circ}\text{C Unless Otherwise Specified})$ Min.		teristic Typ.	Values Max.		
BV _{DSS}	$V_{GS} = 0V, I_D = 1mA$	1000			V
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 4mA$	3.5		6.5	V
I _{gss}	$V_{GS} = \pm 30V$, $V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$				μА
	T _J = 125°C			1.25	mΑ
R _{DS(on)}	V _{GS} = 10V, I _D = 0.5 • I _{D25} , Note 1			660	mΩ



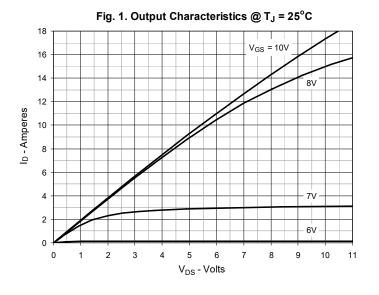
Symbol Test Conditions Characteristic Value		alues		
$(T_J = 25^{\circ}C U)$	Inless Otherwise Specified)	Min.	Тур.	Max.
g _{fs}	$V_{DS} = 20V, I_{D} = 0.5 \bullet I_{D25}, Note 1$	9	16	S
C _{iss}			4890	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		400	pF
C _{rss}			34	pF
\mathbf{R}_{Gi}	Gate Input Resistance		0.20	Ω
t _{d(on)}	Butting a training		37	ns
t, (Resistive Switching Times		32	ns
t _{d(off)}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		40	ns
t,)	$R_{_{G}} = 3\Omega$ (External)		13	ns
$Q_{g(on)}$			90	nC
Q _{gs}	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		33	nC
\mathbf{Q}_{gd}			37	nC
R _{thJC}				0.15 °C/W
R _{thCS}	TO-247		0.21	°C/W

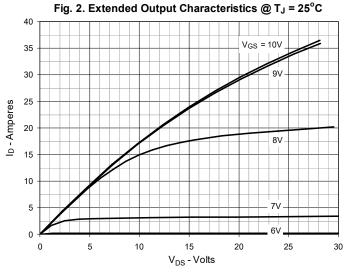
Source-Drain Diode

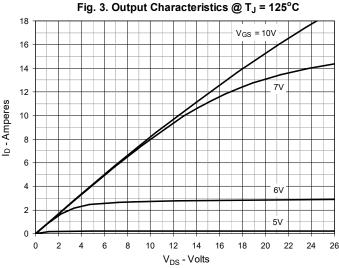
Symbol	Test Conditions	Characteristic Values			
$(T_J = 25^{\circ}C U)$	nless Otherwise Specified)	Min.	Тур.	Max.	
I _s	$V_{GS} = 0V$			18	Α
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			72	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.4	V
t _{rr}	L = 9A -di/dt = 100A/us			300	ns
I _{RM}	$I_F = 9A$, -di/dt = 100A/ μ s $V_R = 100V$, $V_{GS} = 0V$		11.0		Α
\mathbf{Q}_{RM}	$\mathbf{v}_{R} = 100V, \ \mathbf{v}_{GS} = 0V$		1.5		μC

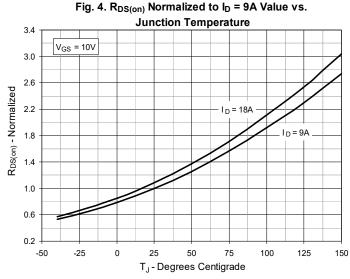
Note 1. Pulse test, $t \le 300 \mu s$, duty cycle, $d \le 2\%$.

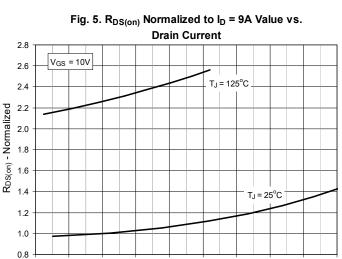




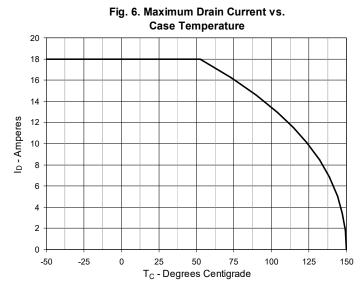




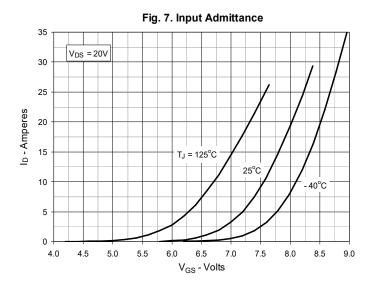


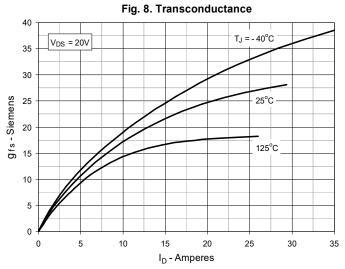


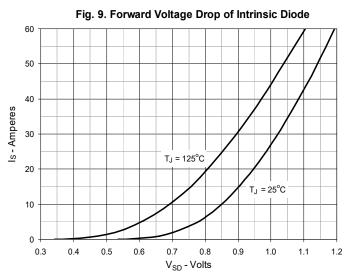
I_D - Amperes

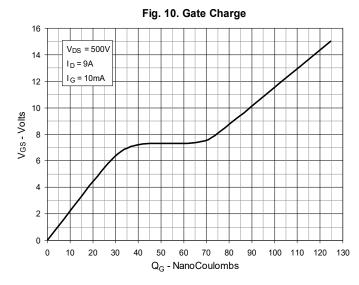


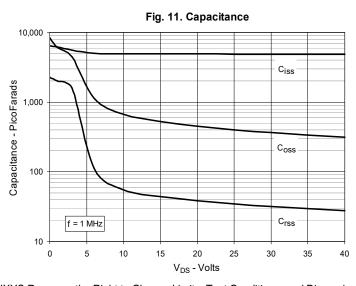


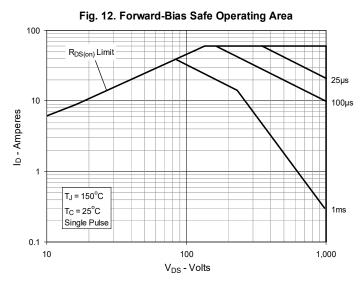






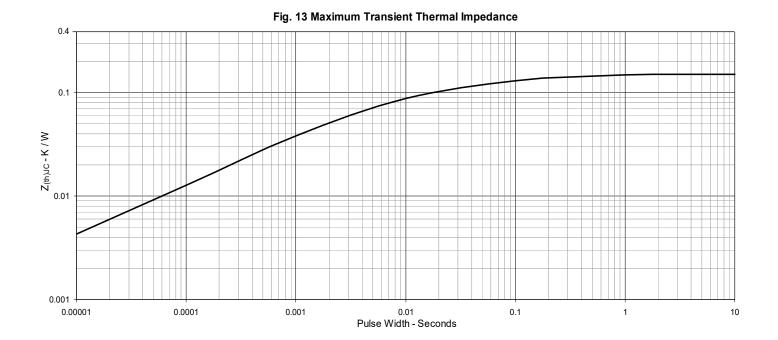






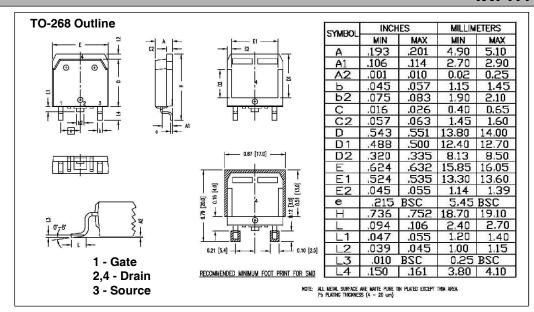
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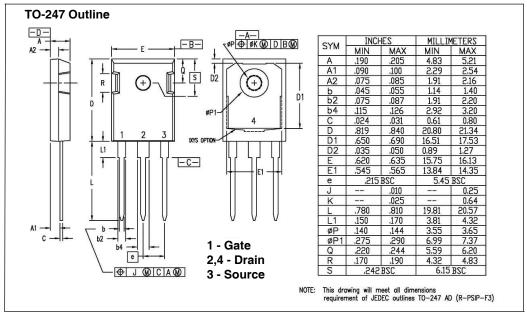




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